

SPECIFICATION

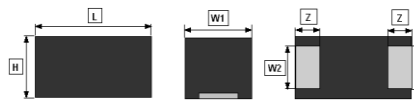
- Supplier : Samsung Electro-Mechanics
- Product : Polymer Tantalum Capacitor

- Samsung P/N : TCPCF0J476MNAR201T
- Description : CAP,TANTAL,47 μ F,6.3V, \pm 20%,2012-08

A. Samsung Part Number

TC PCF 0J 476 M N A R 201 T
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩

① Tantalum Capacitor	TC			
② Series	PCF			
③ Rated Voltage	6.3V			
④ Capacitance	47 μ F			
⑤ Capacitance tolerance	\pm 20%			
⑥ Case size code	2012-08	L: 2.0 \pm 0.2 mm H: 0.8 \pm 0.1 mm	W1: 1.25 \pm 0.2 mm W2: 0.9 \pm 0.1 mm	Z: 0.5 \pm 0.2 mm
⑦ Packing code	7" reel			
⑧ Taping code	Taping direction code			
⑨ ESR	200 m Ω 20 \times 10 ¹			
⑩ Height	0.9mm max			



B. Reliability Test and Judgment Condition

Item	Performance	Test condition
Capacitance	Within specified tolerance	120Hz, maximum 1.0Vrms, 1.0~2.0V D.C, at 25 $^{\circ}$ C
Tan δ (DF)	Within specified value	120Hz, maximum 1.0Vrms, 1.0~2.0V D.C, at 25 $^{\circ}$ C
Impedance(Z) & ESR	Within specified value	100kHz at 25 $^{\circ}$ C
Leakage current	Within specified value	The rated DC voltage shall be applied to terminals across the test capacitor. Charge time : 5mins
Temperature Characteristics	"-55 $^{\circ}$ C : Δ C/C -20~0% "+105 $^{\circ}$ C : Δ C/C 0~+30%	From -55 $^{\circ}$ C to 105 $^{\circ}$ C
Adhesion Strength (Shear Strength)	No peeling shall be occur on the terminal electrode	1005mm size : 2N, for 10 \pm 1 sec. 1608~7343mm size : 5N, for 10 \pm 1 sec.
Electrode Strength (Bending Strength)	Within specified tolerance Tan δ , LC : initial spec.	Bending to the limit (3mm) with 1.0mm/sec.
Solder ability	More than 95% of terminal surface is to be soldered newly	Sn-3Ag-0.5Cu solder : 245 \pm 2 $^{\circ}$ C, 3 \pm 0.3sec
Resistance to Soldering heat	Capacitance change : within \pm 20% Tan : 1.3 times of Initial specification. LC : 3 times of Initial specification.	Solder pot : 260 \pm 5 $^{\circ}$ C, 10 \pm 1sec.
Vibration Test	Capacitance change : within \pm 5% Tan δ , LC : initial spec.	Amplitude : 1.5mm From 10Hz to 55Hz (return : 1min.) 2hours \times 3 direction (x, y, z)
Resistance to Moisture	Capacitance change : -30~+35% Tan : 1.5 times of Initial specification. LC : 3 times of Initial specification.	40 \pm 2 $^{\circ}$ C, 90~95%RH, 500 +8/-0hrs
Load life (High Temperature Resistance)	Capacitance change : -30~+30% Tan : 85 $^{\circ}$ C \rightarrow 1.5times of Initial specification. 105 $^{\circ}$ C \rightarrow 3 times of Initial specification. LC : 1.5 times of Initial specification.	Rated voltage at 85 $^{\circ}$ C Derated voltage(0.8Vr) at 105 $^{\circ}$ C 2000 +48/-0hrs
Temperature Cycling	Capacitance change : within \pm 20% Tan : within initial specification. LC : 3 times of Initial specification.	1 cycle condition (-55 $^{\circ}$ C \rightarrow 25 $^{\circ}$ C \rightarrow 105 $^{\circ}$ C \rightarrow 25 $^{\circ}$ C) 5 cycles

C. Recommended Soldering method

Reflow (Reflow Peak Temperature : 260 $^{\circ}$ C +0/-5 $^{\circ}$ C, 5sec max)

D. Ratings & Part Number Reference

Part Number	Capacitance	Leakage Current	DF	ESR
TCPCF0J476MNAR201T	47 μ F	59.2 μ A	10%	200m Ω

Allowable ripple current (100kHz @ 25 $^{\circ}$ C): 440mArms

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